

Three Phase Motor Predriver IC for automotive





Built-in the Phase adjustment control and 180°energizing drive Three Phase Motor Predriver

BD16805FV-M

General Description

BD16805FV-M is three phase motor driver for air conditioner blower motor, battery cooling fan motor, and seat cooling fan motor. This IC can implement silent drive by 180° energizing drive. The BD16805FV-M includes a built-in phase adjustment control function to drive highly effective. The setting that can correspond to various motor controls is possible. (PWM frequency, Overcurrent protection limit, Start time and Lock protection)

Features

- AEC-Q100 Qualified
- 180° energizing
- Phase adjustment control
- Built-in charge pump
- Built-in MUTE return and uptime setting
- Normal rotation/reversal rotation switch function
- 1FG/3FG switch function
- Speed control by DC input and PWM input
- Output mode can be selected
- Built-in overcurrent protection circuit(OCP) (With limit adjustment function)
- Lock protection function
- Built-in under voltage protection circuit(UVLO)
- Built-in over voltage protection circuit(OVP)
- Built-in thermal shutdown (TSD)

Packages

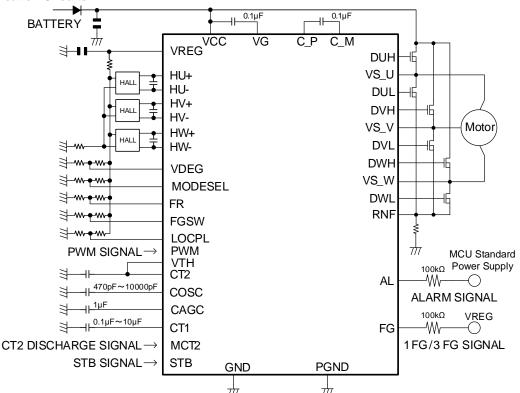
SSOP-B40

13.6mm x 7.80mm x 1.80mm

Applications

- Air conditioner blower motor
- Battery cooling fan motor
- Seat cooling fan motor

● Typical Application Circuits



OProduct structure: Silicon monolithic integrated circuit OThis product is not designed protection against radioactive rays.

● Absolute Maximum Ratings (Ta=25°C)

| Parameter | Symbol | Limits | Unit | |
|-----------------------------|---|----------|------|--|
| Power supply voltage | ower supply voltage VCC | | | |
| Input voltage 1 | STB | 7 | V | |
| Input voltage 2 | PWM / FR / MODESEL / VDEG / FGSW / VTH / MCT2 | VREG+0.7 | V | |
| | D*H / VS_U / VS_V / VS_W | 60 | V | |
| Output voltage | D*L | 15 | V | |
| | FG/AL | 7 | V | |
| Power dissipation | Pd | 1.125 | W | |
| Operating temperature range | Topr | -40~+110 | °C | |
| Storage temperature range | Tstg | -55~+150 | °C | |
| Joint part temperature | Tjmax | 150 | °C | |

■ Recommended Operating Conditions (Ta=-40°C~+110°C)

| | , | | |
|-------------------------------|--------|--------|------|
| Parameter | Symbol | Limits | Unit |
| Power supply voltage range of | VCC | 8~18 | V |
| operation | V00 | 0 10 | v |

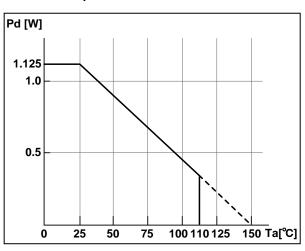
Exceed neither Pd nor ASO.

ROHM standard board (70mm x 70mm x 1.6mm, glass epoxy standard board) Reduce by 9.0mW/°C at Ta ≥ 25°C

Block Diagram

C P VCC Charge pump C_M OVP **VREG** VREG UVLO VG FR DUH ש עs_u HU+ HŪ-DUL PWM CONTROL HV+ DVH HV-Ļ∨s_v DVL HW+ HW-DWH VS W **VDEG** HALL MATRIX DWL **PWM PGND** OCP **RNF** CT2 LOCPL VTHMCT2 LOCK CT1 MODESEL ΑL CAGC COSC OSC TSD FG LOGIC FGSW I STANDBY STB

Power Dissipation

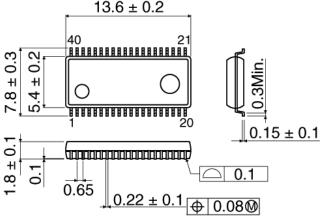


ROHM standard board (70mm x 70mm x1.6mm,

glass epoxy standard board)

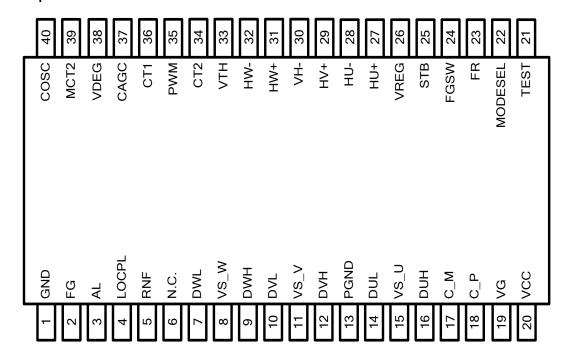
Reduce by 9.0mW/°C at Ta ≥ 25°C





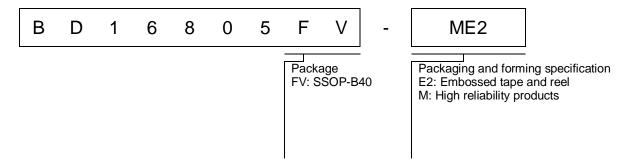
GND

●Pin Description



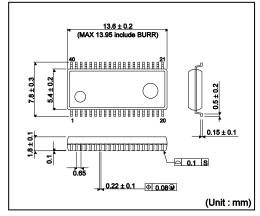
| No. | Symbol | Description | No. | Symbol | Description |
|-----|--------|---|-----|---------|---|
| 1 | GND | GND terminal | 21 | TEST | TEST terminal |
| 2 | FG | 1FG / 3FG output terminal | 22 | MODESEL | Output mode selection terminal |
| 3 | AL | Alarm signal output terminal | 23 | FR | Normal rotation/reversal rotation switch terminal |
| 4 | LOCPL | Current limit setting terminal | 24 | FGSW | 1FG / 3FG switch terminal |
| 5 | RNF | Current detection terminal | 25 | STB | Stand by terminal |
| 6 | N.C. | N.C. | 26 | VREG | Internal standard power supply terminal |
| 7 | DWL | W phase L side FET drive output terminal | 27 | HU+ | Hall input terminal |
| 8 | VS_W | W phase Motor output terminal | 28 | HU- | Hall input terminal |
| 9 | DWH | W phase H side FET drive output terminal | 29 | HV+ | Hall input terminal |
| 10 | DVL | V phase L side FET drive output terminal | 30 | HV- | Hall input terminal |
| 11 | VS_V | V phase Motor output terminal | 31 | HW+ | Hall input terminal |
| 12 | DVH | V phase H side FET drive output terminal | 32 | HW- | Hall input terminal |
| 13 | PGND | POWER GND terminal | 33 | VTH | Control input terminal(DC) |
| 14 | DUL | U phase L side FET drive output terminal | 34 | CT2 | MUTE return and uptime setting terminal |
| 15 | VS_U | U phase Motor output terminal | 35 | PWM | Control input terminal(PWM) |
| 16 | DUH | U phase H side FET drive output terminal | 36 | CT1 | Lock protection time setting terminal |
| 17 | C_M | Charge pump capacitor connection terminal- | 37 | CAGC | Capacitor for phase amends |
| 18 | C_P | Charge pump capacitor connection terminal + | 38 | VDEG | Phase adjustment control |
| 19 | VG | Predriver circuit power supply terminal | 39 | MCT2 | CT2 connection for capacitor discharge terminal |
| 20 | VCC | Power supply terminal | 40 | COSC | PWM frequency setting terminal |

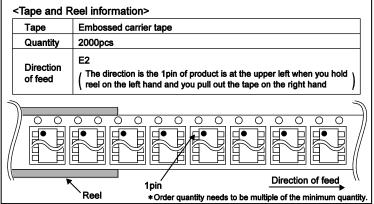
Ordering Information



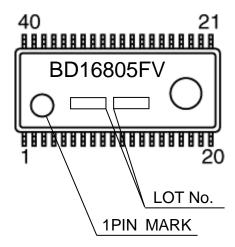
● Physical Dimension and Packing Information

SSOP-B40





Marking Diagram



ullet Electrical Characteristics (Unless otherwise noted, VCC=8V ~ 18V, Ta=-40°C ~+110°C, Hall input amplitude=100mVpp, VEDG=2.5V, COSC=1000pF, Between C_P and C_M=0.1μF, between VG and VCC=0.1μF, CAGC=1μF, VS_U=VS_V=VS_W=GND $\mbox{\%}1$)

| Parameter | Symbol | Limits | | Unit | Condition | |
|-------------------------------------|-----------|----------|------|------|-----------|--------------------------------------|
| raiaillelei | Зунтвог | MIN. | TYP. | MAX. | Uffil | Condition |
| [Whole] | | | | | | |
| Circuit current 1 | ICC1 | - | 0 | 10 | μA | STB=L ※2 |
| Circuit current 2 | ICC2 | - | 15.2 | 30.4 | mA | STB=H, VTH=0V VS_U,VS_V,VS_W=open |
| 【Hall amplifier】 | | | | | | |
| Input bias current | IB | -10 | 0 | +10 | μA | |
| Input level | VINH | 45 | - | - | mVpp | Both sides input level |
| Range of phase input | VHAR | 1.3 | - | 3.7 | V | |
| [VREG terminal] | | | | | | |
| VREG voltage | VREG | 5.2 | 5.5 | 5.8 | ٧ | At -20mA SOURCE ※3 |
| [STB terminal] | | | | | | |
| "L" Range of level voltage | VSTBL | 0 | - | 1.0 | V | |
| "H" Range of level voltage | VSTBH | 3.0 | - | VREG | V | |
| Outflow current | ISTBL | - | - | 10 | μΑ | VSTB=0V |
| Inflow current | ISTBH | 20 | 40 | 80 | μΑ | VSTB=5V |
| [PWM terminal] | | | | | | |
| "L" Range of level voltage | VPWML | 0 | - | 1.0 | V | |
| "H" Range of level voltage | VPWMH | 3.0 | - | VREG | V | |
| Outflow current | IPWML | - | - | 10 | μΑ | VPWM=0V |
| Inflow current | IPWMH | 25 | 50 | 100 | μΑ | VPWM=5V |
| Output resistance | RPWM | 80 | 200 | 320 | kΩ | |
| Input dead zone output ON DUTY1 | ONDUTY1 | 9.5 | 12.5 | 15.5 | % | Figure -4 reference |
| Input dead zone output OFF DUTY1 | OFFDUTY1 | 4.5 | 7.5 | 10.5 | % | Figure -4 reference |
| Input dead zone output OFF DUTY2 | OFFDUTY2 | 95.5 | 97.5 | 99.5 | % | Figure -4 reference |
| Input dead zone output ON DUTY2 | ONDUTY2 | 90.5 | 92.5 | 94.5 | % | Figure -4 reference |
| Input dead zone hysteresis width 12 | DUTYHYS12 | 3 | 5 | 7 | % | Figure -4 reference |
| Voltage L of torque input mask | TQML | 0.5 | 2.5 | 4.5 | % | VMODESEL=H Figure -8 reference |
| 【VTH terminal】 | | | | | | |
| Predriver output DUTY1 | DUTY 1 | 49.1 | 56.6 | 64.1 | % | VTH=1.0V ※4 Figure -9 reference |
| Predriver output DUTY2 | DUTY 2 | 59.2 | 66.7 | 74.2 | % | VTH=2.0V ※4 Figure -9 reference |
| Predriver output DUTY3 | DUTY 3 | 65.8 | 73.3 | 80.8 | % | VTH=2.4V %4 Figure -9 reference |
| Predriver output DUTY4 | DUTY 4 | 75.7 | 83.2 | 90.7 | % | VTH=2.9V ※4 Figure -9 reference |
| [VDEG terminal] | | <u>-</u> | • | • | | - |
| Range of Phase adjustment control | VVDEG | 27 | 30 | 33 | deg | VDEG=0V |
| Phase adjustment control accuracy | FHDEG | -3 | 0 | +3 | deg | VDEG=2.5V |

 $^{\%1\} VS_U,\ VS_W=GND$ only at measuring electric characteristics. In normal operation, please connect to motor output of each phase

X2 Please set input pins (PWM pin, FR pin, MODESEL pin, VDEG pin, FGSW pin, VTH pin, MCT2 pin) to 0V

³ Please connect to phase compensation capacitor $1\mu F$ or more between the VREG and GND.

 $^{\% 4 \ \}text{Measure output DUTY with condition of applying 2.5 Vpp standard } \pm 100 \text{mV DC to hall inputs and 2.2 Vpp to COSC in Test mode.}$

● Electrical Characteristics (Unless otherwise noted, VCC=8V ~ 18V, Ta=-40°C ~ +110°C, Hall input amplitude=100mVpp, VEDG=2.5V, COSC=1000pF, Between C_P and C_M=0.1μF, between VG and VCC=0.1μF, CAGC=1μF, VS_U=VS_V=VS_W=GND %1)

| Doromotor | Cumhal | | Limits | | Unit | Condition | |
|--|-----------------------|------|--------|------|------|----------------------------|--|
| Parameter | Symbol | MIN. | TYP. | MAX. | Unit | Condition | |
| [COSC terminal] | | | | | | | |
| OSC frequency | FOSC | 17.5 | 25 | 32.5 | kHz | COSC=1000pF %5 | |
| [FR terminal] | | | | | | | |
| "L" Range of level voltage | VFRL | 0 | - | 1.0 | V | | |
| "H" Range of level voltage | VFRH | 3.0 | - | VREG | V | | |
| Outflow current | IFRL | - | - | 10 | μA | VFR=0V | |
| Inflow current | IFRH | 25 | 50 | 100 | μA | VFR=5V | |
| [FGSW terminal] | | | | | | | |
| 1FG Range of level voltage | VFG1L | 0 | - | 1.0 | V | | |
| 3FG Range of level voltage | VFG3H | 3.0 | - | VREG | V | | |
| Outflow current | IFG1L | - | - | 10 | μA | VFGSW=0V | |
| Inflow current | IFG3H | 25 | 50 | 100 | μA | VFGSW=5V | |
| [MODESEL terminal] | | | | | | | |
| "L" Range of level voltage | VMODEL | 0 | - | 1.0 | V | | |
| "H" Range of level voltage | VMODEH | 3.0 | - | VREG | V | | |
| Outflow current | IMODEL | - | - | 10 | μA | VMODESEL=0V | |
| Inflow current | IMODEH | 25 | 50 | 100 | μA | VMODESEL=5V | |
| [AL terminal] | | | | | | | |
| "L" Range of level voltage | VALL | 0 | - | 0.3 | V | AL=5V input (PULL UP100kΩ) | |
| "H" Range of level voltage | VALH | 4.8 | 5 | - | V | AL=5V input (PULL UP100kΩ) | |
| [FG terminal] | | | | | | | |
| "L" Range of level voltage | VFGL | 0 | - | 0.3 | V | FG=5V input (PULL UP100kΩ) | |
| "H" Range of level voltage | VFGH | 4.8 | 5 | - | V | FG=5V input (PULL UP100kΩ) | |
| 【LOCPL terminal】 | | | | | | | |
| Overcurrent detection COMP offset | VOCP OFFSET | -10 | - | +10 | mV | LOCPL=20mV, 200mV | |
| OCP MUTE delay time | OCPMUTET ₀ | - | - | 20 | μs | | |
| OCP release delay time | OCPMUTET ₁ | 15 | 36 | 65 | μs | | |
| [CT1 terminal] | | | | | | | |
| SOURCE current for lock protection detection | ILOCK | 0.5 | 1 | 1.5 | μA | Figure-3 reference | |
| CT1 SW ON resistance for Discharge | RONCT1 | - | 81 | 320 | Ω | Figure-3 reference | |
| CT1 Leakage at SW OFF for Discharge | ILEAKCT1 | - | 0 | 1 | μΑ | Figure-3 reference | |
| CT1 Comparison H Voltage | VLOCKP_H | 3.40 | 3.85 | 4.30 | V | | |
| CT1 Comparison L Voltage | VLOCKP_L | 0.45 | 0.55 | 0.65 | V | | |

^{%5} Please use COSC within the range of 470pF-10000pF.

ullet Electrical Characteristics (Unless otherwise noted, VCC=8V ~ 18V, Ta=-40°C ~ +110°C, Hall input amplitude=100mVpp, VEDG=2.5V, COSC=1000pF, Between C_P and C_M=0.1μF, between VG and VCC=0.1μF, CAGC=1μF, VS_U=VS_V=VS_W=GND %1)

| Parameter | Symbol | | Limits | | Unit | Condition |
|-------------------------------|------------|-------|--------|-------|------|-------------------|
| Parameter | Symbol | MIN. | TYP. | MAX. | Unit | Condition |
| [MCT2 terminal] | | | | | | |
| "L" Range of level voltage | VMCT2L | 0 | - | 1.0 | V | |
| "H" Range of level voltage | VMCT2H | 3.0 | - | VREG | V | |
| Inflow current | IMCT2L | - | - | 10 | μΑ | VMCT2=0V |
| Outflow current | IMCT2H | 25 | 50 | 100 | μA | VMCT2=5V |
| CT2 STBY | | | | | • | |
| SW ON resistance | RONCT2 | _ | 105 | 260 | Ω | VMCT2=5V |
| for Discharge | | | | | | |
| CT2 Leakage at SW OFF for | U 5 ALCOTO | | _ | 4 | • | |
| Discharge | ILEAKCT2 | - | 0 | 1 | μΑ | |
| [VG terminal] | | | | | | |
| Drogouro voltogo 4 | VC4 | 2xVCC | 2xVCC | 2xVCC | \/ | V/CC 9V/2-141 EV/ |
| Pressure voltage 1 | VG1 | -1.5 | -0.5 | +0.5 | V | VCC=8V~11.5V |
| Drocoure veltage 2 | V/C2 | VCC | VCC | VCC | V | \/CC_11 |
| Pressure voltage 2 | VG2 | +10 | +11.5 | +13 | V | VCC=11.5V~18V |
| Dragovino voltorio 2 | VC2 | | 0.0 | 1.0 | \ / | VG drop voltage |
| Pressure voltage 3 | VG3 | - | 0.6 | 1.0 | V | at -5mA SOURCE |
| [Predriver output terminal] | | | | | | |
| D*H H voltage1 | VOHH1 | 23 | - | 31 | V | VCC=18V ※6 |
| D*H L voltage1 | VOHL1 | - | 0 | 0.2 | > | VCC=18V ※6 |
| D*L H voltage1 | VOLH1 | 10 | - | 13 | > | VCC=18V ※6 |
| D*L L voltage1 | VOLL1 | - | 0 | 0.2 | > | VCC=18V ※6 |
| D*H H voltage2 | VOHH2 | 13.5 | - | 16.5 | V | VCC=8V %6 |
| D*H L voltage2 | VOHL2 | - | 0 | 0.2 | V | VCC=8V %6 |
| D*L H voltage2 | VOLH2 | 7.5 | - | 8.5 | V | VCC=8V %6 |
| D*L L voltage2 | VOLL2 | - | 0 | 0.2 | V | VCC=8V %6 |
| D*H Standing up slew rate 1 | VOHUSR1 | 14 | - | 55 | V/µs | VCC=18V %6 |
| D*H Standing fall slew rate 1 | VOHDSR1 | 30 | - | 120 | V/µs | VCC=18V %6 |
| D*L Standing up slew rate 1 | VOLUSR1 | 14 | - | 60 | V/µs | VCC=18V %6 |
| D*L Standing fall slew rate 1 | VOLDSR1 | 20 | - | 85 | V/µs | VCC=18V %6 |
| D*H Standing up slew rate 2 | VOHUSR2 | 14 | - | 45 | V/µs | VCC=8V %6 |
| D*H Standing fall slew rate 2 | VOHDSR2 | 14 | - | 70 | V/µs | VCC=8V %6 |
| D*L Standing up slew rate 2 | VOLUSR2 | 14 | - | 50 | V/µs | VCC=8V %6 |
| D*L Standing fall slew rate 2 | VOLDSR2 | 14 | - | 55 | V/µs | VCC=8V %6 |
| D*H D*L | | | 6.5= | | | |
| Dead Time(Standing up) | TDEAD | 0.30 | 0.95 | 3.00 | μs | |
| [Others] | | - | | | | |
| Over voltage detection | VOVP | 25 | 30 | 35 | V | |
| Under voltage detection | VUVLO | 5.3 | 5.8 | 6.3 | V | |

^{%6} Measure when the capacitor of 10000pF is connected with the output as external MOS-FET gate capacitance.

Timing Chart

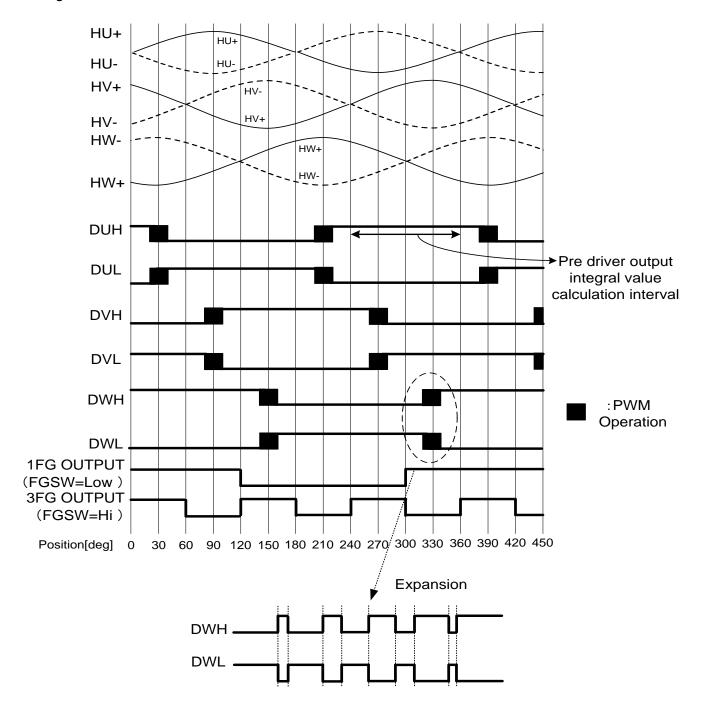


Figure -1(a) Timing chart (FR=L: Forward)

●Timing Chart - continued

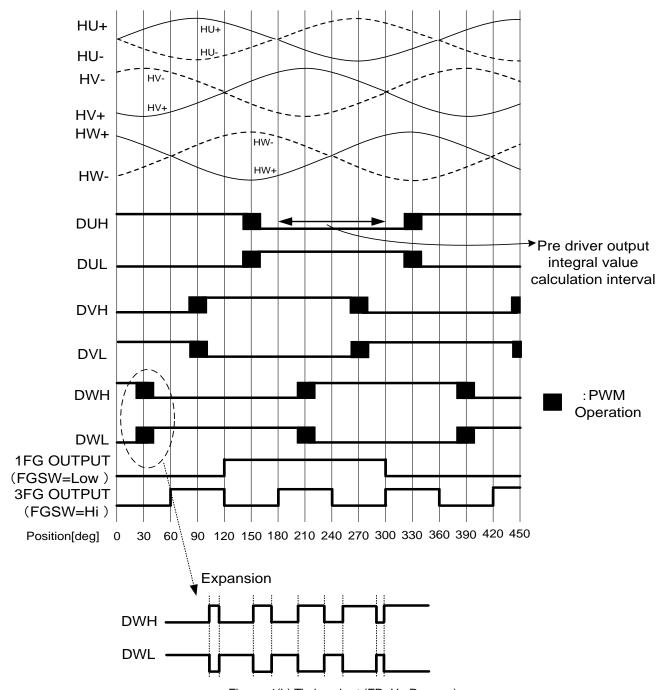


Figure -1(b) Timing chart (FR=H: Reverse)

Operation Explanation

1. The state of the output at each MUTE

| Protection mode | AL (Alarm signal) | Predriver output (D*H) | Predriver output (D*L) | Charge pump output |
|--------------------------|----------------------|---------------------------|---------------------------|--------------------|
| Over current protection | Low | Low | Low | ACTIVE |
| Lock protection | Low | Low | Low | ACTIVE |
| Under voltage protection | Hi | Low | Low | ACTIVE |
| Over voltage protection | Low | Low | Low | MUTE |
| Thermal shutdown | Low | Low | Low | ACTIVE |

2. Current limit (overcurrent protection circuit)

Current limit current I is decided by the resistance setting of LOCPL and the RNF current detection terminal. A current limit operates by the value decided as shown in the figure below by the following calculation types. Please use the setting range of LOCPL with 20mV-200mV. Please use it noting S/N when setting LOCPL by a low value.

I=V1 / RNF

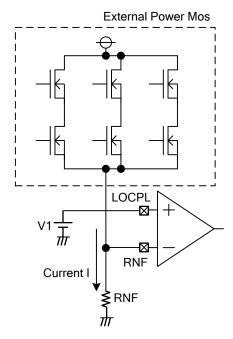


Figure -2(a) Overcurrent limit equivalent circuit diagram

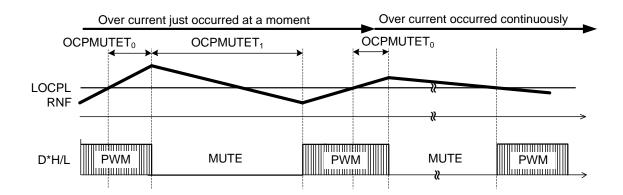


Figure -2(b) Overcurrent Protection Timing chart

3. Lock protection function

If hall input signal is stop, the lock protection circuit is determined that detection of lock protection. When the lock protection circuit is detect lock protection, all predriver output is fix to Low.

Terminal CT1 capacitor and lock protection ON time (TON1) TON1(Charging time)=(VLOCKP_H- VLOCKP_L) / (ILOCK/C)

C: CT1 Capacity of terminal external capacitor

ILOCK: SOURCE current for lock protection detection (TYP::1µA) VLOCKP_H: Terminal CT1 comparison H voltage (TYP::3.85V) VLOCKP_L: Terminal CT1 comparison L voltage (TYP::0.55V)

Reference value (example)

At CT1=1μF

 $TON1=(3.85-0.55)V/(1\mu A/1\mu F)=3.3s$

At CT1=10µF

 $TON1=(3.85-0.55)V/(1\mu A/10\mu F)=33s$

Our company is recommending the range of $0.1\mu\text{F}-10\mu\text{F}$ to the capacitor of CT1. CT1 is shorted to GND when the lock protection time is not set.

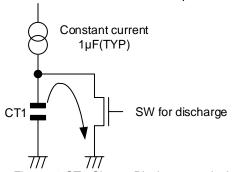


Figure -3 CT1 Charge Discharge equivalent circuit chart

When the lock protection is released and it reactivates, the CT1 capacitor should be completely discharged. Discharge SW of Figure-3 is turned on to integral value 47.7% as shown in Figure-7, 8. Please raise PWM input DUTY after discharging the CT1 capacitor.

(Reference)

The discharge time is decided by the expression of $\Delta V = (1 - e^{-t/(C \times R)}) \times \Delta V$ (initial value).

At t= C x R, it becomes the standing fall time of 63.2%.

ON resistance of SW for CT1 discharge becomes MAX.=320Ω.

(Refer to electric characteristic CT1 terminal item P.6.)

4. Over power supply voltage output OFF function

Over power supply voltage output OFF function is built into as output protection at the over voltage. When the impressed voltage to the terminal VCC becomes 30V (TYP.) or more, all Predriver output terminal becomes Low. However, it is only STB=Hi as the operation condition. Please note that this function doesn't operate because the current supply also stop in IC at STB=Low (At the standby).

Over power supply voltage output OFF function is built into. Please do not exceed the absolute maximum rating so that there is a possibility of destruction when the absolute maximum rating of the power supply voltage is exceeded.

5. Torque input instruction<PWM input DUTY • VTH(DC input)>
This circuit compares OSC (triangular wave) and the voltage proportional to torque.

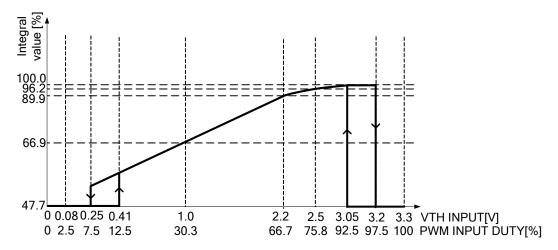


Figure -4 PWM INPUT DUTY, VTH(DC INPUT) vs OUTPUT DUTY (MODESEL=L)

Integral value in Figure-4 is measured in 120°interval (please refer to Figure-1(a), (b)) Hysterics has been installed in PWM input DUTY (VTH input). 12.5%(0.41V) (TYP.) > is PWM DUTY of standing up in the lower side, and 7.5%(0.25V) (TYP.) is PWM DUTY of the standing fall.

97.5%(3.2V) (TYP.) is PWM DUTY of the standing fall in the upper side, and 92.5%(3.05V) (TYP.) is PWM DUTY of standing up. PWM input DUTY (VTH input) can control the torque output voltage by 12.5%(0.41V)-97.5%(3.2V) (TYP.). It becomes similar set about 12.5%-97.5% torque output voltage at MODESEL=HI.

OSC (triangular wave) and the voltage proportional to torque are compared by 2.5V standard. Figure-5 becomes the torque output voltages and shape of waves of triangular wave when VTH=2.5V is input.

The amplitude of the torque output voltage compared with a triangular wave changes when VTH is changed such as Figure-4.

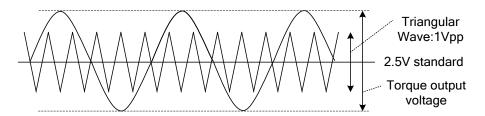


Figure -5 OCS (Triangular wave) and TORQUE OUTPUT VOLTAGE

(Using the PWM or DC input)

The capacitor is connected with CT2 and be short-circuited with the terminal VTH and use it when using PWM input DUTY control. Please impress the input to VTH and control when using VTH(DC input) control. Please install the R-C filter by external when installing the start delay. When DC and PWM are input, it is possible to discharge of the capacitor in the terminal MCT2.

6. OSC (PWM oscillation frequency)

The oscillation frequency can be arbitrarily set with an external capacitor (terminal COSC). The theoretical formula of the oscillation frequency is as follows.

Oscillation frequency [Hz]=1 / (COSC/25µA)

Please use the range where external capacitor (COSC) can be set with 470pF-10000pF.

7. Start time and the deceleration time (brake)

When making it to ACTIVE(STB=Hi) from the standby(STB=Low), start time can be given to the output. The time of the deceleration (brake) operates the same time as a start time.

The start return time and the deceleration time are indicated in Figure-6.

Because the start return time is decided CT2 external capacitor and internal resistance of IC, it is possible to adjust it with CT2 external capacitor.

(The following Refer to the expression of start and deceleration time)

(Reference) Terminal CT2 capacitor, start time, and deceleration time (TON2) are

TON2=C x R

C : Capacity of terminal CT2 external capacitor R : Internal resistance of IC (TYP. : $200k\Omega$)

Reference value (Example)

At CT2=1µF,

TON2=1 μ F x 200 $k\Omega$ =0.2s

At CT2=10μF,

TON2=10μF x 200k Ω =2.0s

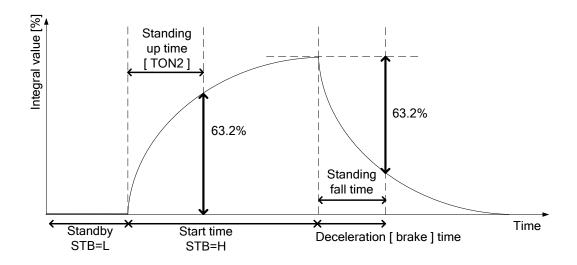


Figure -6 Start time • Deceleration (brake) timing chart

A set value of CT2 holds PWM smooth input concurrently.

The shake accuracy after smoothness influences output DUTY accuracy. Please confirm the DUTY change and set the optimal value.

The smoothness of PWM is recommended to set the cutoff frequency by 1/10 or less of the PWM input frequencies. Please consult once when the PWM input frequency is used excluding the above-mentioned regulations.

(Reference)

fc (cutoff frequency) =1 / $(2\pi CR)$

R : TYP. : $200 k\Omega$ by internal resistance of IC (RPWM)

C : Capacity of terminal CT2 external capacitor

When making it to ACTIVE(STB=Hi) from the standby(STB=Low), the CT2 capacitor should be completely discharged. Please fix the PWM input to DUTY 0% and discharge it by $200k\Omega(TYP.)$ resistance or please make to SW=HI(MCT2=5V) (ON resistance MAX.= 260Ω) for MCT2 discharge for the discharge of the CT2 capacitor (Figure-4).

8. Output mode selection

The output mode form becomes and two following selections become possible by the voltage of the terminal MODESEL is impressed to L(0V - 1.0V) and H(3.0V - VREG).

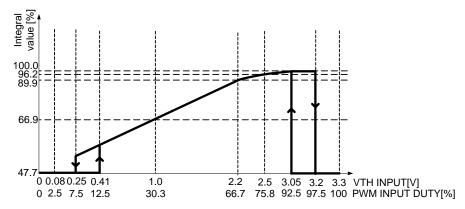


Figure -7 PWM input DUTY (VTH input) vs OUTPUT DUTY (MODESEL=L)

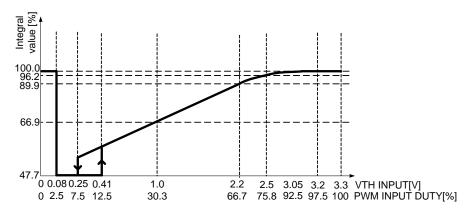


Figure -8 PWM input DUTY (VTH input) vs OUTPUT DUTY (MODESEL=H)

9. TEST terminal

It is a test terminal among our company and please fix TEST terminal to Low.

10. External constant

Our company designs within the range of an external constant described in application circuit diagram.

Please consult our company once though there is a thing that the characteristic cannot guarantee, when the change is necessary.

11. Predriver Output DUTY

Predriver Output DUTY is measured in Test mode.

Peak voltage of torque output at VTH=1V, 2V, 2.4V and 2.9V is shown at $\bigcirc \sim \textcircled{4}$ in Figure-9 in measurement of predriver output DUTY. For measuring predriver output DUTY, hall input is applied with DC voltage considerably to torque peak voltage of $\bigcirc \sim \textcircled{4}$ (hall input amplitude is assumed as 100mVpp). In this condition, torque output voltage is shown in Figure-9 as $\bigcirc \sim \textcircled{4}$. In addition, triangular waveform amplitude of COSC becomes 2.2Vpp. DUTY of predriver output is measured by comparison of voltage of $\bigcirc \sim \textcircled{4}$ and triangular waveform 2.2Vpp

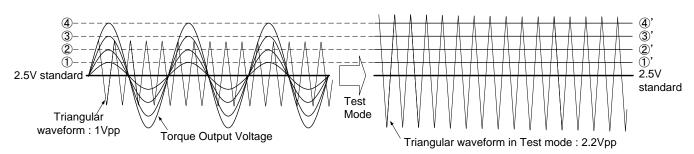


Figure -9 PREDRIVER OUTPUT DUTY Measure method

Operational Notes

1) We are careful enough for quality control about this IC. So, there is no problem under normal operation, excluding that it exceeds the absolute maximum ratings. However, this IC might be destroyed when the absolute maximum ratings, such as impressed voltages (VCC) or the operating temperature range, is exceeded, and whether the destruction is short circuit mode or open circuit mode cannot be specified. Please take into consideration the physical countermeasures for safety, such as fusing, if a particular mode that exceeds the absolute maximum rating is assumed.

2) GND line

The ground line is where the lowest potential and transient voltages are connected to the IC.

3) Input terminal

Please do not add the voltage to each input terminal when you do not impress VCC to IC.

4) BEMF

BEMF might be changed depending on use conditions and an individual characteristic of the environment and the motor. Please confirm there is no problem in the operation of IC by BEMF.

5) VCC

Please put coupling capacitor 10µF or more in the power supply between the power supply and GND.

6) Power dissipation

Power dissipation is changed by the state of the substrate mounting and the mounting environment of IC, and take care enough about the heat design.

7) Power consumption

Power consumption changes greatly depending on the power-supply voltage and the output current. Please design heat after considering the thermal resistance data and the transition thermal resistance data, etc. to consider power dissipation, and so as not to exceed ratings.

8) ASO

Please set not to exceed ASO (area of safe operation) the output current and the power-supply voltage.

- 9) The circuit that limits the inrush current is not built into this IC. Therefore, please consider physical measures of putting the current limitation resistance.
- 10) There is a possibility that the trouble of the malfunction occurs if the potential of the output terminal widely swings to the potential of GND or less in this IC according to conditions such as the generation of heat condition, power-supply voltages, and the use motors. For that case, please consider measures where trouble doesn't occur as shot key diode is added between GND-output.

11) Radiation

This IC doesn't do the design that assumes use in strong electromagnetic field. Please confirm there is no problem in the operation of IC by the substrate pattern layout and the circuit constant enough.

12) Thermal shutdown

The thermal shutdown circuit is built into as an overheating protection measures this IC. When the Chip temperature of IC becomes 175°C (TYP.) or more, the output is opened. It returns to normal operation when becoming 150°C (TYP.) or less.

13) FG output signal

When the noise is generated in the hall signal, the FG signal might do chattering. Especially, the possibility that chattering is caused as the power-supply voltage touches rises when rapidly changing from the normal rotation into the reversal rotation or from the reversal rotation into the normal rotation. CAPA is inserted between the hall input terminals to decrease the noise of the hall signal, and the attention such as enlarging the input level is necessary when using it like this.

Operational Notes - continued

14) Wrong direction assembly of the device.

Use caution when positioning the IC for mounting on printed circuit boards. The IC may be damaged if there is any connection error.

15) Regarding input pin of the IC I

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements to keep them isolated. PN junctions are formed at the intersection of these P layers with the N layers of other elements, creating a parasitic diode or transistor. For example, the relation between each potential is as follows:

When GND > Pin A and GND > Pin B, the PN junction operates as a parasitic diode. When Pin B > GND > Pin A, the PN junction operates as a parasitic transistor.

Parasitic diodes can occur inevitably in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Accordingly, methods by which parasitic diodes operate, such as applying a voltage that is lower than the GND (P substrate) voltage to an input pin, should not be used

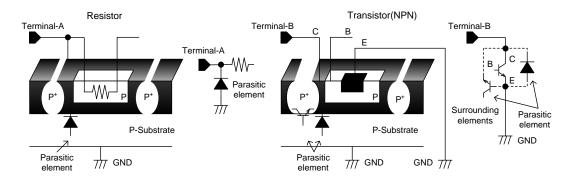


Figure -10 Simplified structure of IC

Status of this document

The Japanese version of this document is formal specification. A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document formal version takes priority.

Revision History

| evision History | | |
|-----------------|----------|--|
| Date | Revision | Changes |
| 24.Jan.2012 | 001 | New Release |
| 06.Oct.2016 | 004 | Change point for Rev.003 to Rev.004 p.1 Features Change function name. "low voltage" to "under voltage" Change function name. "overvoltage" to "over voltage" p.5 ¾4 Correction of mistake. " and 2.5Vpp to " to "and 2.2Vpp to" p.6 [LOCPL terminal] Change symbol. "CPMUTET" to "OCPMUTET" Change symbol. "OCPMUTET" to "OCPMUTET1" p.7 [Others] Change item name. "Off voltage at overvoltage" to "Over voltage detection" Change item name. "Off voltage at reduce voltage" to "Under voltage detection" p.10 Figure-2(b) Change waveform name. "D*H/L MUTE" to "D*H/L" Change waveform name. "(Blank)" to "MUTE" p.11 3. Lock protection function Change symbol. "ILOCK2" to "ILOCK" Change sentence. p.11 4. Over power supply voltage output OFF function Change words. "Overpower-supply" to "Over power supply" Change words. "overvoltage" to "over voltage" Change words. "power-supply" to "power supply" p.12 6. OSC (PWM oscillation frequency [kHz]" to "Oscillation frequency [Hz]" p.14 11. Predriver Output DUTY Change figure name. "Figure-9(a)" to "Figure-9" |
| 25.Jan.2019 | 005 | Change figure name. "Figure-9 (b)" to "Figure-9" All pages Unity font and paragraph. All pages Index New Release p.2, 5, 6, 7 Range notation Add symbol. "-xx~xx" to "-xx~+xx" p.11, 12, 13, 14, 16 Item name Add item name for cross the page. p.8, 9 Item name Add item name. "(Blank)" to "●Timing Chart" p.2 Recommended Operating Conditions Correction of mistake. "(Ta=25°C)" to "(Ta=-40°C~+110°C)" p.2 Power Dissipation Correction of mistake. "Power Dissipaton" to "Power Dissipation" p.3 Terminal name Change format. p.4 Ordering Information Change format. p.11 3. Lock protection function Correction of mistake. "integral value 50% as" to "integral value 47.7% as" Correction of mistake. "terminal item P.3.)" to "terminal item P.6.)" p.15 Operational Notes Change item name. "Cautions on use" to "Operational Notes" p.17 Revision History New Release |

Notice

Precaution on using ROHM Products

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

| ſ | JAPAN USA | | EU | CHINA | |
|---|-----------|-----------|------------|--------|--|
| Ī | CLASSⅢ | CL ACCIII | CLASS II b | СГУССШ | |
| ſ | CLASSIV | CLASSⅢ | CLASSⅢ | CLASSⅢ | |

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Precaution for Disposition

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